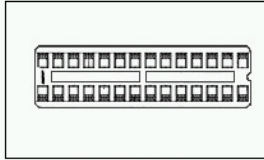# 1-390261-9 Product Details

Have a Question?
Chat with a Product Information Specialist

1-390261-9

TE Internal Number: 1-390261-9
✔ Active

📄 View 3D PDF

DIP Sockets

🍃 Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:
- Socket Style = Standard
- Through Hole Contact Termination Type
- 2.54 mm Centerline
- Row-to-Row Spacing = 7.62 mm
- 28 Positions

View all Features

📥 Add to My Part List 📦 Request Sample 🌐 Find Similar Products 🪙 Buy Product

Quick Links
- Check Pricing & Availability
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- Product Feature Selector
- Contact Us About This Product

Documentation & Additional Information

Product Drawings:
- DIP SOCKET, .300 CENTER LINE LADDER STYLE (PDF, English)

Catalog Pages/Data Sheets:
- None Available

Product Specifications:
- None Available

Application Specifications:
- None Available

Instruction Sheets:
- None Available

CAD Files: (CAD Format & Compression Information)
- 2D Drawing (DXF, Version M)
- 3D Model (IGES, Version M)
- 3D Model (STEP, Version M)

Additional Information:
- Product Line Information

Related Products:
- Tooling

List all Documents

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:
- Socket Style = Standard
- Profile = Standard
- Frame Style = Ladder
- Leg Style = Straight
- PCB Mount Angle = Horizontal

Electrical Characteristics:
- Insulation Resistance (MΩ) = 10,000
- Contact Resistance (mΩ) = 30

Termination Related Features:
- Termination Post Length (mm [in]) = 3.00 [0.118]

Body Related Features:
- Centerline (mm [in]) = 2.54 [0.100]
- Row-to-Row Spacing (mm [in]) = 7.62 [0.300]
- Number of Positions = 28
- Mount Style = Vertical

Contact Related Features:
- Contact Termination Type = Through Hole
- Contact Base Material = Phosphor Bronze
- Contact Plating, Mating Area, Material = Tin
- Contact Style = Stamped + Formed
- Mating Contact Type = Dual Leaf

Configuration Related Features:
- Height Above PC Board (mm [in]) = 5.10 [0.200]

Industry Standards:
- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Wave solder capable to 240°C, Wave solder capable to 260°C, Wave solder capable to 265°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Conditions for Usage:
- Temperature Range (°C) = -40 – +105

Packaging Related Features:
- Packaging Method = Tube

Other:
- Brand = AMP

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